

1.Scope

This specification applies to the HDSDRH 73/74/124/125/127/129 series of SMD power inductors.

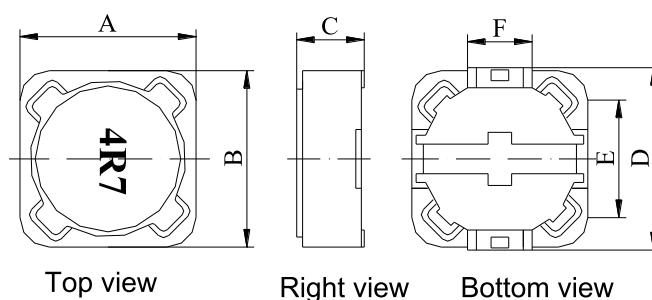
2.Product Identification

HDSDRH 74 - 4R7 M - LF
 ① ② ③ ④ ⑤

- ① Product Symbol
- ② Dimensions (12*12*6mm)
- ③ Inductance Value (6R8:6.8uH 680:68uH; 101:100 uH 252:2500 uH)
- ④ Inductance Tolerance (K:10% ; M:20% N:30%)
- ⑤ Lead-Free

3. Construction

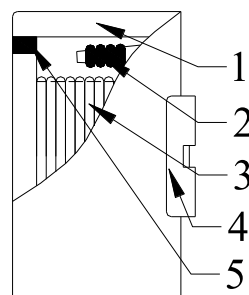
3.1 Shape And Dimensions



Dimensions in mm						
Model	A	B	C	D	E	F
HDSDRH73	7.3±0.3	7.3±0.3	3.5Max	7.3±0.5	4.8 Ref	2.5 Ref
HDSDRH74	7.3±0.3	7.3±0.3	4.5Max	7.3±0.5	4.8 Ref	2.5 Ref
HDSDRH124	12.0±0.3	12.0±0.3	5.0Max	12.0±0.5	7.6 Ref	5.0±0.2
HDSDRH125	12.0±0.3	12.0±0.3	6.0Max	12.0±0.5	7.6 Ref	5.0±0.2
HDSDRH127	12.0±0.3	12.0±0.3	8.0Max	12.0±0.5	7.6 Ref	5.0±0.2
HDSDRH129	12.0±0.3	12.0±0.3	10.0Max	12.0±0.5	7.6 Ref	5.0±0.2

4.Material List

No.	Item	Material
1	Core	Ni-Zn Ferrite
2	Solder	Sn-0.7Cu
3	Wire	Copper Wire
4	Terminal Electrode	Copper plated with Sn
5	Epoxy	Epoxy



5. Testing Conditions

Unless otherwise specified

Temperature : Ordinary Temperature (5 to 35°C)

Humidity : Ordinary Humidity (<70% RH)

Atmospheric Pressure : 86 to 106 kPa

In case of doubt

Temperature : 20±2°C

Humidity : 50 to 65% RH

Atmospheric Pressure : 86 to 106 kPa

6. Electrical Characteristics And Test Instruments

Operating temperature:-40~125°C

Storage temperature and Humidity Range: -10~40°C & 30 to 70%

HDSDRH73 Size

HONGDA Part No.	Inductance (uH)	Test Freq. (KHz)	DCR (Ω) Max.	Rated Current (A)
HDSDRH73-100M-LF	10	100	0.072	1.68
HDSDRH73-120M-LF	12	100	0.098	1.52
HDSDRH73-150M-LF	15	100	0.130	1.33
HDSDRH73-180M-LF	18	100	0.140	1.20
HDSDRH73-220M-LF	22	100	0.190	1.07
HDSDRH73-270M-LF	27	100	0.210	0.96
HDSDRH73-330M-LF	33	100	0.240	0.91
HDSDRH73-390M-LF	39	100	0.320	0.77
HDSDRH73-470M-LF	47	100	0.360	0.76
HDSDRH73-560M-LF	56	100	0.470	0.68
HDSDRH73-680M-LF	68	100	0.520	0.61
HDSDRH73-820M-LF	82	100	0.690	0.57
HDSDRH73-101M-LF	100	100	0.790	0.50
HDSDRH73-121M-LF	120	100	0.890	0.49
HDSDRH73-151M-LF	150	100	1.270	0.43
HDSDRH73-181M-LF	180	100	1.450	0.39
HDSDRH73-221M-LF	220	100	1.650	0.35
HDSDRH73-271M-LF	270	100	2.310	0.32
HDSDRH73-331M-LF	330	100	2.620	0.28
HDSDRH73-391M-LF	390	100	2.940	0.26
HDSDRH73-471M-LF	470	100	4.180	0.24
HDSDRH73-561M-LF	560	100	4.670	0.22
HDSDRH73-681M-LF	680	100	5.730	0.19
HDSDRH73-821M-LF	820	100	6.540	0.18
HDSDRH73-102M-LF	1000	100	9.440	0.16

HSDRH74 Size

HONGDA Part No.	Inductance (uH)	Test Freq. (KHz)	DCR (Ω) Max.	Rated Current (A)
HSDRH74-3R3M-LF	3.3	100	0.032	4.80
HSDRH74-6R8M-LF	6.8	100	0.045	3.00
HSDRH74-8R2M-LF	8.2	100	0.047	2.00
HSDRH74-100M-LF	10	100	0.049	1.84
HSDRH74-120M-LF	12	100	0.058	1.71
HSDRH74-150M-LF	15	100	0.081	1.47
HSDRH74-180M-LF	18	100	0.091	1.31
HSDRH74-220M-LF	22	100	0.110	1.23
HSDRH74-270M-LF	27	100	0.150	1.12
HSDRH74-330M-LF	33	100	0.170	0.96
HSDRH74-390M-LF	39	100	0.230	0.91
HSDRH74-470M-LF	47	100	0.260	0.88
HSDRH74-560M-LF	56	100	0.350	0.75
HSDRH74-680M-LF	68	100	0.380	0.69
HSDRH74-820M-LF	82	100	0.430	0.61
HSDRH74-101M-LF	100	100	0.610	0.60
HSDRH74-121M-LF	120	100	0.660	0.52
HSDRH74-151M-LF	150	100	0.880	0.46
HSDRH74-181M-LF	180	100	0.980	0.42
HSDRH74-221M-LF	220	100	1.170	0.36
HSDRH74-271M-LF	270	100	1.640	0.34
HSDRH74-331M-LF	330	100	1.860	0.32
HSDRH74-391M-LF	390	100	2.850	0.29
HSDRH74-471M-LF	470	100	3.010	0.26
HSDRH74-561M-LF	560	100	3.620	0.23
HSDRH74-681M-LF	680	100	4.630	0.22
HSDRH74-821M-LF	820	100	5.200	0.20
HSDRH74-102M-LF	1000	100	6.000	0.20

HDSDRH124 Size

HONGDA Part No.	Inductance (uH)	Test Freq. (KHz)	DCR (Ω) Max.	Rated Current (A)
HDSDRH124-3R9N-LF	3.9	100	0.015	6.50
HDSDRH124-4R7N-LF	4.7	100	0.018	5.70
HDSDRH124-6R8N-LF	6.8	100	0.023	4.90
HDSDRH124-8R2N-LF	8.2	100	0.026	4.60
HDSDRH124-100M-LF	10	100	0.028	4.50
HDSDRH124-120M-LF	12	100	0.038	4.00
HDSDRH124-150M-LF	15	100	0.050	3.20
HDSDRH124-180M-LF	18	100	0.057	3.10
HDSDRH124-220M-LF	22	100	0.066	2.90
HDSDRH124-270M-LF	27	100	0.080	2.80
HDSDRH124-330M-LF	33	100	0.097	2.70
HDSDRH124-390M-LF	39	100	0.132	2.10
HDSDRH124-470M-LF	47	100	0.150	1.90
HDSDRH124-560M-LF	56	100	0.190	1.80
HDSDRH124-680M-LF	68	100	0.220	1.50
HDSDRH124-820M-LF	82	100	0.260	1.30
HDSDRH124-101M-LF	100	100	0.308	1.20
HDSDRH124-121M-LF	120	100	0.380	1.10
HDSDRH124-151M-LF	150	100	0.530	0.95
HDSDRH124-181M-LF	180	100	0.620	0.85
HDSDRH124-221M-LF	220	100	0.700	0.80
HDSDRH124-271M-LF	270	100	0.870	0.60
HDSDRH124-331M-LF	330	100	0.990	0.50

HSDSRH125 Size

HONGDA Part No.	Inductance (uH)	Test Freq. (KHz)	DCR (Ω) Max.	Rated Current (A)
HSDSRH125-1R3N-LF	1.3	100	0.012	8.00
HSDSRH125-2R1N-LF	2.1	100	0.014	7.00
HSDSRH125-3R1N-LF	3.1	100	0.017	6.00
HSDSRH125-4R4N-LF	4.4	100	0.02	5.00
HSDSRH125-5R8N-LF	5.8	100	0.021	4.40
HSDSRH125-7R5N-LF	7.5	100	0.024	4.20
HSDSRH125-100M-LF	10	100	0.025	4.00
HSDSRH125-120M-LF	12	100	0.027	3.50
HSDSRH125-150M-LF	15	100	0.03	3.30
HSDSRH125-180M-LF	18	100	0.034	3.00
HSDSRH125-220M-LF	22	100	0.036	2.80
HSDSRH125-270M-LF	27	100	0.051	2.30
HSDSRH125-330M-LF	33	100	0.057	2.10
HSDSRH125-390M-LF	39	100	0.068	2.00
HSDSRH125-470M-LF	47	100	0.075	1.80
HSDSRH125-560M-LF	56	100	0.11	1.70
HSDSRH125-680M-LF	68	100	0.12	1.50
HSDSRH125-820M-LF	82	100	0.14	1.40
HSDSRH125-101M-LF	100	100	0.18	1.70
HSDSRH125-121M-LF	120	100	0.17	1.10
HSDSRH125-151M-LF	150	100	0.23	1.00
HSDSRH125-181M-LF	180	100	0.29	0.90
HSDSRH125-221M-LF	220	100	0.4	0.80
HSDSRH125-271M-LF	270	100	0.46	0.75
HSDSRH125-331M-LF	330	100	0.51	0.68
HSDSRH125-391M-LF	390	100	0.69	0.65
HSDSRH125-471M-LF	470	100	0.77	0.58
HSDSRH125-561M-LF	560	100	0.86	0.54
HSDSRH125-681M-LF	680	100	1.2	0.48
HSDSRH125-821M-LF	820	100	1.34	0.43
HSDSRH125-102M-LF	1000	100	1.53	0.40

HDSDRH127 Size

HONGDA Part No.	Inductance (uH)	Test Freq. (KHz)	DCR (Ω) Max.	Rated Current (A)
HDSDRH127-1R2N-LF	1.2	100	0.007	9.80
HDSDRH127-2R4N-LF	2.4	100	0.012	8.00
HDSDRH127-3R5N-LF	3.5	100	0.014	7.50
HDSDRH127-4R7N-LF	4.7	100	0.016	6.80
HDSDRH127-6R1N-LF	6.1	100	0.018	6.60
HDSDRH127-7R6N-LF	7.6	100	0.020	5.90
HDSDRH127-100M-LF	10	100	0.022	5.40
HDSDRH127-120M-LF	12	100	0.025	4.90
HDSDRH127-150M-LF	15	100	0.030	4.50
HDSDRH127-180M-LF	18	100	0.040	3.90
HDSDRH127-220M-LF	22	100	0.044	3.60
HDSDRH127-270M-LF	27	100	0.046	3.40
HDSDRH127-330M-LF	33	100	0.065	3.00
HDSDRH127-390M-LF	39	100	0.075	2.75
MGSDRH127-470M-LF	47	100	0.100	2.50
HDSDRH127-560M-LF	56	100	0.110	2.35
HDSDRH127-680M-LF	68	100	0.140	2.10
HDSDRH127-820M-LF	82	100	0.160	1.95
HDSDRH127-101M-LF	100	100	0.220	1.70
HDSDRH127-121M-LF	120	100	0.250	1.60
HDSDRH127-151M-LF	150	100	0.280	1.40
HDSDRH127-181M-LF	180	100	0.350	1.30
HDSDRH127-221M-LF	220	100	0.390	1.16
HDSDRH127-271M-LF	270	100	0.560	1.06
HDSDRH127-331M-LF	330	100	0.640	0.95
HDSDRH127-391M-LF	390	100	0.700	0.90
HDSDRH127-471M-LF	470	100	0.980	0.79
HDSDRH127-561M-LF	560	100	1.070	0.73
HDSDRH127-681M-LF	680	100	1.460	0.67
HDSDRH127-821M-LF	820	100	1.640	0.60
HDSDRH127-102M-LF	1000	100	1.820	0.55

HDSDRH129 Size

HONGDA Part No.	Inductance (uH)	Test Freq. (KHz)	DCR (Ω) Max.	Rated Current (A)
HDSDRH129-150M-LF	15	100	0.026	8.00
HDSDRH129-390M-LF	39	100	0.058	3.00
HDSDRH129-470M-LF	47	100	0.063	3.60
HDSDRH129-560M-LF	56	100	0.070	2.90
HDSDRH129-680M-LF	68	100	0.100	3.00
HDSDRH129-331M-LF	330	100	0.386	1.28
HDSDRH129-471M-LF	470	100	0.824	1.06
HDSDRH129-681M-LF	680	100	0.730	0.83
HDSDRH129-101M-LF	100	100	0.135	2.31
HDSDRH129-222M-LF	2200	100	4.600	0.30

* CHEN HWA 3202 meter for L and DCR.

* CHEN HWA 3202 and 1310 meter for IDC.

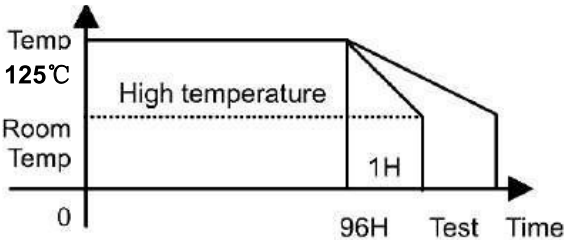
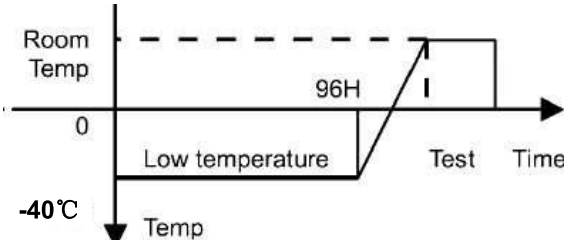
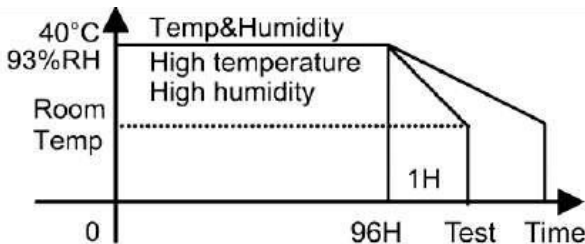
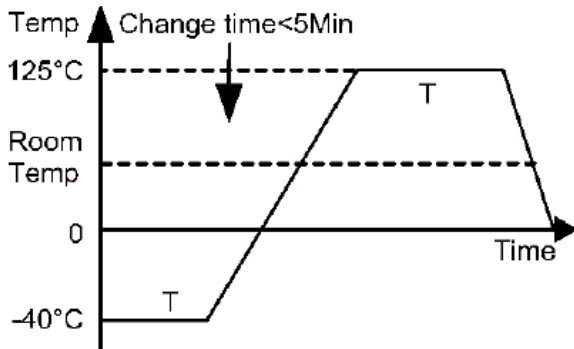
* Test condition: 100KHz/1.0V.

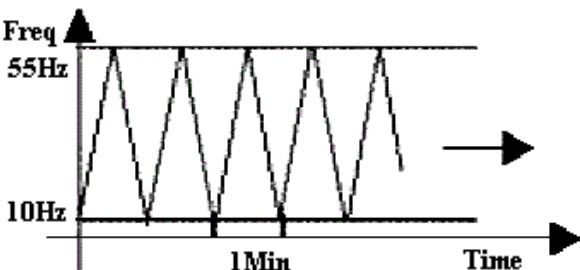
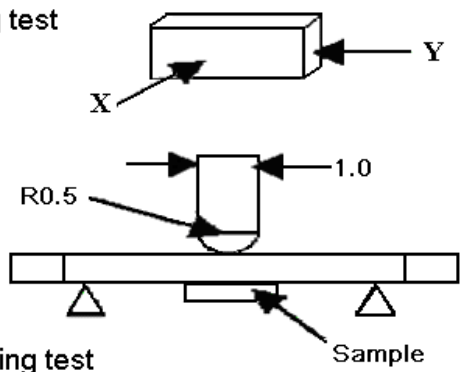
* Isat current (A) that will cause L0 to drop 35% Max.

* Irms current (A) that will cause an approximate ΔT : 40°C.Max.

The part must be allowed high temperature : 125°C

7. Reliability and Test Condition

Item	Required Characteristics	Test Method/Condition						
High temperature storage test		Temperature: 125±2℃ Time : 96±2 hours Tested not less than 1 hours, nor more than 2 hours at room temperature. 						
Low temperature storage test	1. No case deformation or change in appearance. 2. ΔL /L≤10% 3. ΔQ /Q≤30% 4. ΔDCR /DCR≤10%	Temperature : -40±2℃ Time : 96±2 hours Tested not less than 1 hour, nor more than 2 hours at room temperature. 						
Humidity test		1. Dry oven at a temperature of 40±5℃ for 24 hours. 2. Measurements at the end of this period. 3. Exposure : Temperature:40±2℃, Humidity : 93± 3% RH Time : 96±2 hours. 4. Tested while the specimens are still in the chamber. 5. Tested not less than 1 hour, nor more than 2 hours at room temperature. 						
Thermal shock test	1. No case deformation or change in appearance. 2. ΔL /L≤10% 3. ΔQ /Q≤30% 4. ΔDCR /DCR≤10% For T: <table border="1"><thead><tr><th>Weight</th><th>Time</th></tr></thead><tbody><tr><td>W≤28g</td><td>15 Minute</td></tr><tr><td>28g≤W≤136g</td><td>30 Minute</td></tr></tbody></table>	Weight	Time	W≤28g	15 Minute	28g≤W≤136g	30 Minute	First -40℃ for T time, last 125℃ T time as 1 cycle. Go through 20 cycles. 
Weight	Time							
W≤28g	15 Minute							
28g≤W≤136g	30 Minute							

Item	Required Characteristics	Test Method/Condition												
Solderability test	Terminal area must have 95% min. solder coverage.	Dip pads in flux then dip in solder pot at $245\pm 5^{\circ}\text{C}$ for 5 second. Solder: lead free Flux: rosin flux.												
Heat endurance of reflow soldering	1. No case deformation or change in appearance. 2. $ \Delta L /L \leq 10\%$ 3. $ \Delta Q /Q \leq 30\%$ 4. $ \Delta \text{DCR} /\text{DCR} \leq 10\%$	Refer to the next page reflow curve Go through 3 times. The peak temperature: $260\pm 5^{\circ}\text{C}$												
Vibration test		Apply frequency 10~55Hz. 0.75mm amplitude in each of perpendicular direction for 2 hours.(total 6 hours) 												
Drop test		Packaged & drop down from 1m with $981\text{m/s}^2(100\text{G})$ attitude in 1 angle 1 ridges & 2surfaces orientations.												
Terminal strength test	Pulling test: Define: A: sectional area of terminal. <table border="1" data-bbox="359 1332 734 1512"> <thead> <tr> <th>A (mm²)</th><th>Force (N)</th><th>Time (sec.)</th></tr> </thead> <tbody> <tr> <td>$A \leq 8$</td><td>≥ 5</td><td>30</td></tr> <tr> <td>$8 < A \leq 20$</td><td>≥ 10</td><td>10</td></tr> <tr> <td>$A > 20$</td><td>≥ 20</td><td>10</td></tr> </tbody> </table> Bending test: Soldering the products on PCB, after the pulling test and bending test, terminal should not pull off.	A (mm ²)	Force (N)	Time (sec.)	$A \leq 8$	≥ 5	30	$8 < A \leq 20$	≥ 10	10	$A > 20$	≥ 20	10	Bend the testing PCB at middle point, the deflection shall be 2mm. 
A (mm ²)	Force (N)	Time (sec.)												
$A \leq 8$	≥ 5	30												
$8 < A \leq 20$	≥ 10	10												
$A > 20$	≥ 20	10												
Resistance to solvent test	No case deformation or change in appearance, or obliteration of marking	To dip parts into IPA solvent for 50.5Min, then drying them at room temp for 5Min., at last, to brushing marking 10 times.												

8. Recommended Soldering Conditions

Product can be applied to flow and reflow soldering.

(1) Flux, Solder

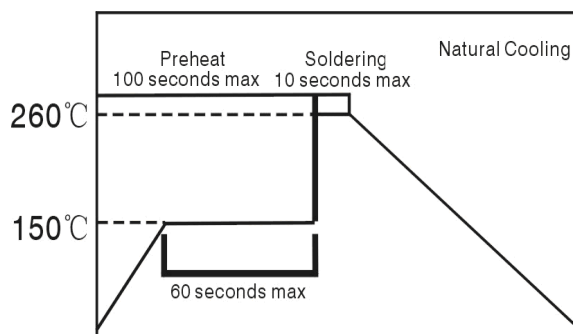
- Use rosin-based flux. Don't use highly acidic flux with halide content exceeding 0.2wt% (chlorine

conversion value).

② Use Sn solder.

(2) Flow soldering conditions

- Pre-heating should be in such a way that the temperature difference between solder and product surface is limited to 150°C max. Cooling into solvent after soldering also should be in such a way that temperature difference is limited to 100°C max. Unwrought pre-heating may cause cracks on the product, resulting in the deterioration of products quality.
- Standard soldering profile.



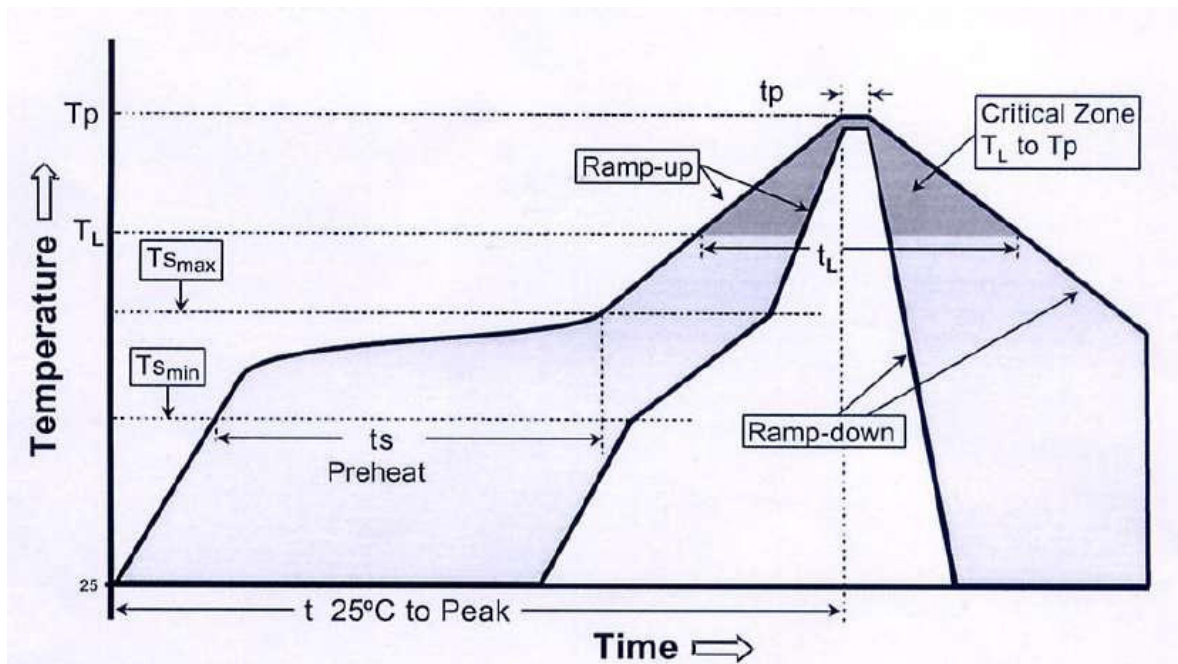
Pre-heating	150°C, 1 minute min
Peak	260°C, 10 seconds max

(3) Reflow soldering conditions

Profile Feature		Lead-Free Assembly
Average Ramp-Up Rate (Ts max. to Tp)		3°C C/second max.
Preheat	– Temperature Min (Ts min.)	150 °C
	– Temperature Max (Ts max.)	200 °C
	– Time (ts min to ts max.)	60-180 seconds
Time maintained above	– Temperature (TL)	217 °C
	– Time (tL)	60-150 seconds
Peak/Classification Temperature (Tp)		260 °C
Peak/Classification Time (Tp)		3-4 seconds
Time within 5 °C of actual Peak Temperature (tp)		20-40 seconds
Ramp-Down Rate		6°C/second max.
Time 25 °C to Peak Temperature		8 minutes max.

Note 1: All temperatures refer to topside of the package, measured on the package body surface.

Reflow curve



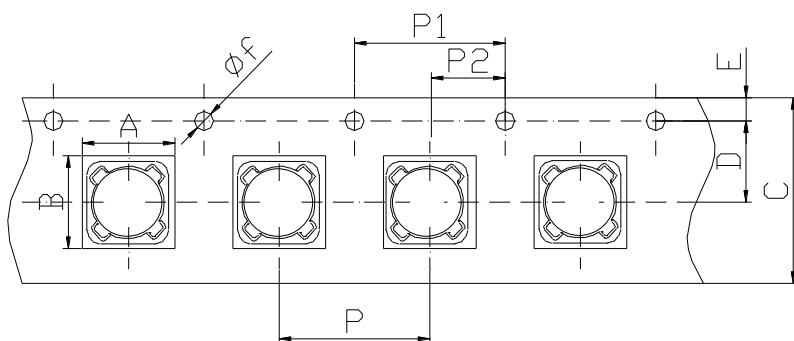
(4) The method on Re-work with using the iron:

The following conditions must be strictly followed when using a soldering iron

Pre-heating	150°C, 1 minute
Tip temperature	280°C max
Soldering iron output	20w max
End of soldering iron	φ1mm max
Soldering time	3 seconds max

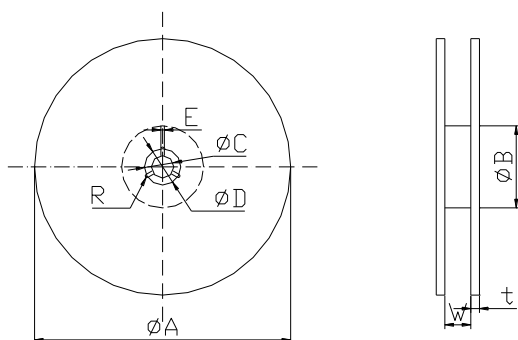
9. Packaging

9.1 Dimension of tape (Unit: mm)



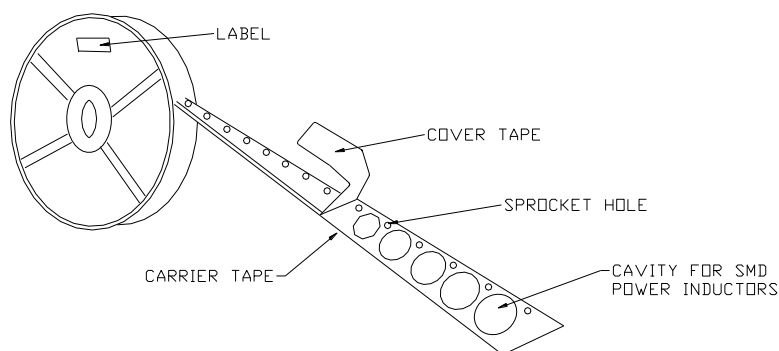
Series	HDSDRH
A	12.6±0.1
B	12.6±0.1
C	24.0±0.3
D	11.5±0.1
E	1.75±0.1
φ f	1.5±0.1
P	16.0±0.1
P1	4.0±0.1
P2	2.0±0.1

9.2 Dimension of reel (Unit: mm)



A	330±2.0
B	100±2.0
C	13.5±0.5
D	21±0.5
E	2.2
R	R1.0
W	24.5
t	2.5

9.3 Taping figure and drawing direction

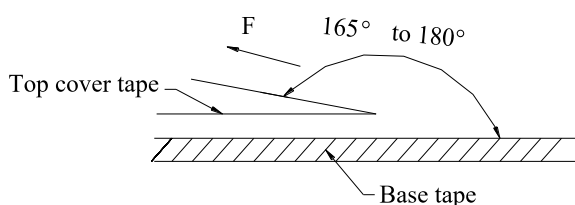


9.4 Packaging quantities:500PCS/Reel.

9.5 Peeling strength Of cover tape:

The force tearing off cover tape is 10 to 130 grams in the arrow direction under the following conditions.

Room Temp. (°C)	Room Humidity (%)	Room aim (hpa)	Peel Speed Mm/min
5-35	45-85	860-1060	300



10. Products Storage

(1) Storage period

Products which inspected in HONGDA over 6 months ago should be examined and used, which can be confirmed with inspection No. marked on the container. Solderability should be checked if this period is exceeded.

(2) Storage conditions

Products should be storage in the warehouse on the following conditions:

Temperature: -10 ~+ 40°C

Humidity : Less than 80% relative and humidity

No rapid change on temperature and humidity

(3) Don't keep products in corrosive gases such as sulfur, chlorine gas or acid, or it may cause oxidization of electrode, resulting in poor solderability.

(4) Products should be storage on the palette for the prevention of the influence from humidity, dust and so on.

(5) Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.

(6) Products should be storage under the airtight packaged condition.